

## 3-pole filter for IMT 2000/CDMA 2000/UMTS/WCDMA

 Series/Type:
 S3S2/14/1

 Ordering code:
 B69813N1957A560

 Date:
 2010-02-16

 Version:
 P8

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Microwave Ceran		B69813N1957A560		
	IT 2000/CDMA 2000/UMTS/WCDMA		S3S2/14/1	
Preliminary data sh	eet			
Modification				
P3	Component drawing	05.01.01	Freising	
P4	Marking	19.11.03	Stadler	
P5	Tape drawing	09.02.04	Freising	
P6	Pieces/tape	26.02.04		
P7	Marking	28.06.04	Freising	

16.02.10

Reichel

Upgraded to new form

## SMD filter consisting of coupled resonators with stepped impedances (NdBa)TiO<sub>3</sub> ( $\epsilon_r$ = 88/TC<sub>f</sub> = 0 ±10 ppm/K) with a coating of copper (10 µm) and tin (>5 µm) Excellent reflow solderability, no migration effect due to copper/tin metallization

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Features

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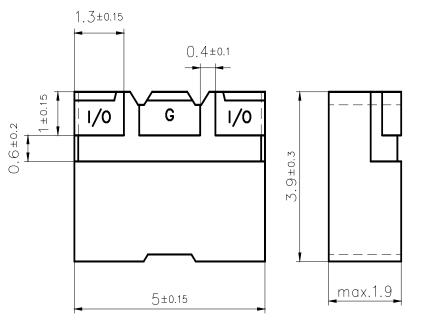


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## B69813N1957A560 S3S2/14/1

Preliminary data sheet

### **Component drawing**



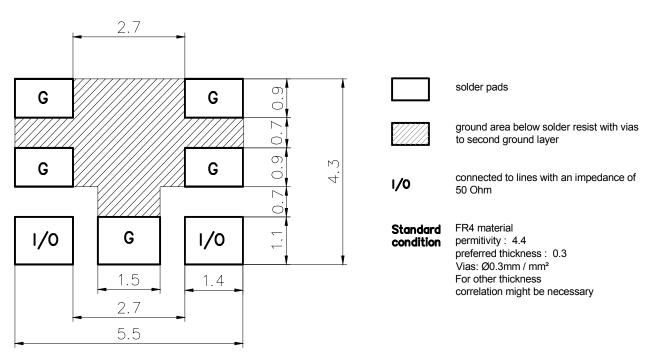


Marking

y= calendar year w= calendar week e.g.: 427= calendar year 2004, calendar week 27

View from below onto the solder terminals and view from beside

### **Recommended footprint**



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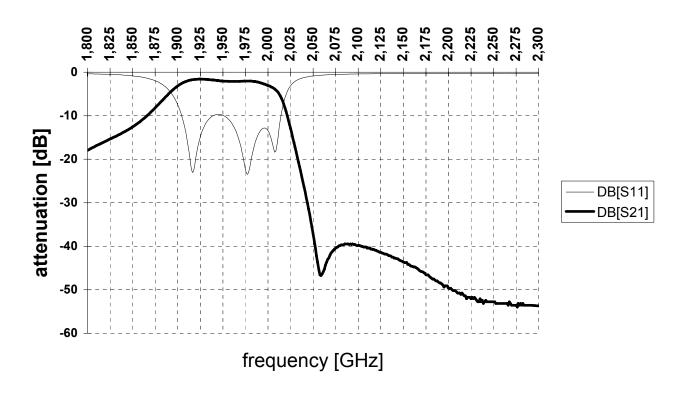
#### Characteristics

		min.	typ.	max.	
Center frequency	f <sub>C</sub>	_	1950	-	MHz
Insertion loss	αιΓ		1.5	1.8	dB
Passband	В	60			MHz
Amplitude ripple (peak – peak)	Δα			1.5	dB
Standing wave ratio	SWR			2.2	
Impedance	Z		50		Ω
Attenuation	α				
at 2110 to 2170 MHz		40			dB

#### Maximum ratings

IEC climatic category (IEC 68-1)		-40 °C/+90 °C/56	
Operating temperature	т <sub>ор</sub>	-25/+85	°C

#### Typical passband characteristic



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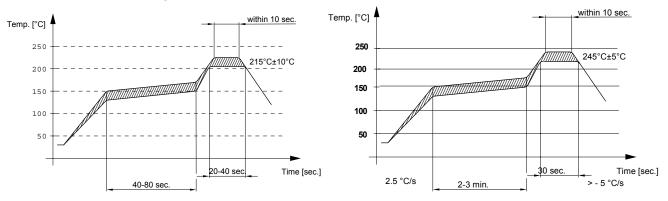
#### **Processing information**

■ Wettability acc. to IEC 68-2-58: ≥75% (after aging)

#### Soldering requirements

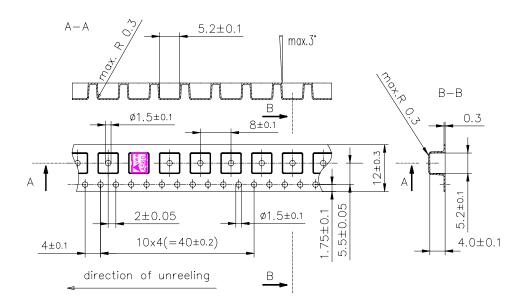
	Profile for eutectic SnPb solder paste	Profile for leadfree solder paste	
Soldering type	reflow	reflow	
Maximum soldering temperature	235 (max. 2 sec.)	260 (max. 2 sec.)	°C
(measuring point on top surface of the component)	225 (max. 10 sec.)	250 (max. 10 sec.)	°C

#### Recommended soldering conditions (infrared):



#### **Delivery mode**

- Blister tape acc. to IEC 286-3, PS, grey
- Pieces/tape: 3000



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